



### **Features**

- Tri-rate 1.0625G/2.125G/4.25Gbps
- Up to 150m transmission on 50/125  $\mu$  m MMF at bit rate 4.25Gbps
- Up to 70m transmission on 62.5/125 μ m MMF at bit rate 4.25Gbps
- 850nm VCSEL and PIN photodetector
- Digital diagnostic monitor interface compatible with SFF-8472
- SFP MSA package with duplex LC connector
- +3.3V single power supply
- Operating case temperature: -5~+70°C
- RoHS compliant

# **Regulatory Compliance**

**Table 1 - Absolute Maximum Ratings** 

Electrostatic Discharge	MIL-STD-883E	Class 1		
(ESD) to the Electrical Pins	Method 3015.7	Class I		
Electrostatic Discharge (ESD) to the	IEC 61000-4-2	Compliant with standards		
Duplex LC Receptacle	IEC 61000-4-2	Compliant with standards		
Electromagnetic	FCC Part 15 Class B	Compliant with standards		
Interference (EMI)	FCC Falt 15 Class B	Compliant with standards		
Laser Eye Safety	FDA 21CFR 1040.10 and 1040.11	Compliant with Class I laser		
Laser Lye Salety	EN (IEC) 60825-1,2	product.		
RoHS	2002/95/EC 4.1&4.2	Compliant with PoHS		
ROHS	2005/747/EC	Compliant with RoHS		

## **Absolute Maximum Ratings**

**Table 2 - Absolute Maximum Ratings** 

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Storage Temperature	Ts	-40	-	+85	°C	
Supply Voltage	V <sub>CC</sub>	-0.5	-	+3.6	V	
Operating Relative Humidity	RH	+5	-	+95	%	



# **Recommended Operating Conditions**

Table 3 - Recommended Operating Conditions

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Operating Case Temperature	T <sub>C</sub>	-5	-	+70	°C	
Power Supply Voltage	V <sub>CC</sub>	3.13	3.3	3.47	V	
Power Supply Current	I <sub>cc</sub>	-	180	240	mA	
Power Dissipation	P <sub>D</sub>	-	-	0.8	W	
Data Rate		1.0625		4.25	Gbps	

# **Optical Characteristics**

**Table 4 – Optical Characteristics** 

		Transmitt	er				
Paran	neter	Symbol	Min.	Typical	Max.	Unit	Notes
Centre Wavelength		λ <sub>C</sub>	830	850	860	nm	
Average Output Power		P <sub>0ut</sub>	-9		-2.5	dBm	1
Spectral Width (RMS)		σ			0.85	nm	
Optical Modulation	4.25 Gb/s		247				
Optical Modulation Amplitude	2.125 Gb/s	OMA	196			μ <b>W</b>	2
Amplitude	1.0625 Gb/s		156				
Rise/Fall time (20% -	4.25 Gb/s				90		
80%)	2.125 Gb/s	t <sub>r</sub> /t <sub>f</sub>			150	ps	3
00 70)	1.0625 Gb/s				300		
Relative Intensity Noise		RIN			-118	dB/Hz	
Total Jitter		TJ			0.44	UI	4
Deterministic Jitter		$D_J$			0.26	UI	4
		Receive					
Centre Wavelength		$\lambda_{C}$	770		860	nm	
	4.25 Gb/s				-14		
Receiver Sensitivity	2.125 Gb/s				-16	dBm	5
	1.0625 Gb/s				-17		
Receiver Overload			0				
Return Loss			12			dB	
LOS De-Assert		LOSD			-20	dBm	
LOS Assert		LOSA	-30			dBm	
LOS Hysteresis			0.5		4	dB	
Total Jitter (pk-pk)		TJ			0.64	UI	4



Deterministic Jitter (pk-pk)	DJ			0.39	UI	4	
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#### Notes:

- 1. The optical power is launched into MMF.
- 2. Optical modulation amplitude values are peak-to-peak for Fibre Channels which are equivalent to extinction ratio specification. Allows smaller ER at higher average power.
- 3. Optical rise and fall time specifications are based on the unfiltered waveforms.
- 4. Measured with a PRBS 2<sup>7</sup>-1 test pattern@4.25/2.125Gbps, meet the specified maximum output jitter requirements if the specified maximum input jitter is present.
- 5. Specifications are for 50 micro-meter or 62.5 micro-meter fiber.

### **Electrical Characteristics**

Table 5 - Electrical Characteristics

Transmitter									
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes			
Data Input Swing Differential	V <sub>IN</sub>	500		2400	mV	1			
Input Differential Impedance	Z <sub>IN</sub>	90	100	110	Ω				
Tx_DIS Disable	V <sub>D</sub>	2.0		V <sub>CC</sub>	V				
Tx_DIS Enable	V <sub>EN</sub>	GND		GND+0.8	V				
TX_ Fault (Fault)		2.0		Vcc+0.3	V				
TX_ Fault (Normal)		0		0.8	V				
		Receiver							
Data Output Swing Differential	V <sub>OUT</sub>	370		2000	mV	1			
Rx_LOS Fault	V <sub>LOS-Fault</sub>	2.0		Vcc+0.3	V				
Rx_LOS Normal	V <sub>LOS-Normal</sub>	GND		GND+0.8	V				

### Notes:

1. Internally AC coupled

## **Recommended Host Board Power Supply Circuit**

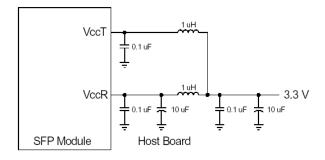


Figure 1, Recommended Host Board Power Supply Circuit



### **Recommended Interface Circuit**

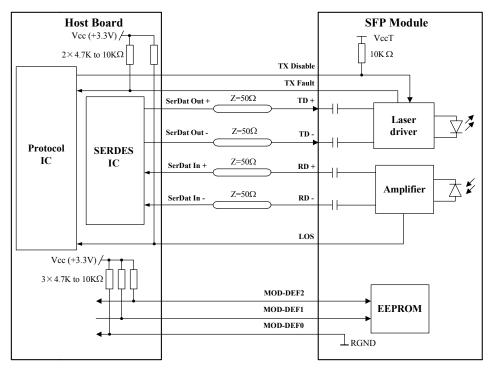


Figure 2, Recommended Interface Circuit

### **Pin Definitions**

Figure 3 below shows the pin numbering of SFP electrical interface. The pin functions are described in Table 6 with some accompanying notes.

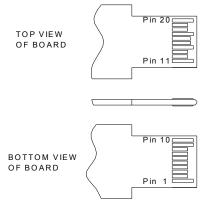


Figure 3, Pin View



Table 6 - Pin Function Definitions

Pin No.	Name	Function	Plug Seq.	Notes
1	VeeT	Transmitter Ground	1	
2	TX Fault	Transmitter Fault Indication	3	Note 1
3	TX Disable	Transmitter Disable	3	Note 2
4	MOD-DEF2	Module Definition 2	3	Note 3
5	MOD-DEF1	Module Definition 1	3	Note 3
6	MOD-DEF0	Module Definition 0	3	Note 3
7	Rate Select	Not Connected	3	
8	LOS	Loss of Signal	3	Note 4
9	VeeR	Receiver Ground	1	
10	VeeR	Receiver Ground	1	
11	VeeR	Receiver Ground	1	
12	RD-	Inv. Received Data Out	3	Note 5
13	RD+	Received Data Out	3	Note 5
14	VeeR	Receiver Ground	1	
15	VccR	Receiver Power	2	
16	VccT	Transmitter Power	2	
17	VeeT	Transmitter Ground	1	
18	TD+	Transmit Data In	3	Note 6
19	TD-	Inv. Transmit Data In	3	Note 6
20	VeeT	Transmitter Ground	1	

#### Notes:

- TX Fault is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.
- 2. TX Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a  $4.7k\sim10k\Omega$  resistor. Its states are:

Low (0 $\sim$ 0.8V): Transmitter on (>0.8V, <2.0V): Undefined

High (2.0~3.465V): Transmitter Disabled Open: Transmitter Disabled

- 3. MOD-DEF 0,1,2 are the module definition pins. They should be pulled up with a  $4.7k\sim10k\Omega$  resistor on the host board. The pull-up voltage shall be VccT or VccR.
  - MOD-DEF 0 is grounded by the module to indicate that the module is present
  - MOD-DEF 1 is the clock line of two wires serial interface for serial ID
  - MOD-DEF 2 is the data line of two wires serial interface for serial ID
- 4. LOS is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; logic 1 indicates loss of signal. In the low state, the output will be pulled to less than 0.8V.



- 5. These are the differential receiver output. They are internally AC-coupled  $100\Omega$  differential lines which should be terminated with  $100\Omega$  (differential) at the user SERDES.
- 6. These are the differential transmitter inputs. They are AC-coupled, differential lines with  $100\Omega$  differential termination inside the module.

### **EEPROM Information**

The SFP MSA defines a 256-byte memory map in EEPROM describing the transceiver's capabilities, standard interfaces, manufacturer, and other information, which is accessible over a 2 wire serial interface at the 8-bit address 1010000X (A0h). The memory contents refer to Table 7.

Table 7 - EEPROM Serial ID Memory Contents (A0h)

	Field			
Addr.	Size	Name of Field	Hex	Description
	(Bytes)			
0	1	Identifier	03	SFP
1	1	Ext. Identifier	04	MOD4
2	1	Connector	07	LC
3—10	8	Transceiver	00 00 00 01 20 40 0C 15	1000BASE-SX,400/200/100-M5/6-SN-I
11	1	Encoding	01	8B10B
12	1	BR, nominal	2A	4.25Gbps
13	1	Reserved	00	
14	1	Length (9um)-km	00	
15	1	Length (9um)	00	
16	1	Length (50um)	0F	150m
17	1	Length (62.5um)	07	70m
18	1	Length (copper)	00	
19	1	Reserved	00	
20—35	16	Vendor name	53 4F 55 52 43 45 50 48	"SOURCEPHOTONICS"(ASC II )
20—35	10	vendoi name	4F 54 4F 4E 49 43 53 20	SOURCEPHOTONICS (ASCII)
36	1	Reserved	00	
37—39	3	Vendor OUI	00 00 00	
40 55	16	Vander DN	53 50 34 46 53 58 43 44	"CD4ECVCDEA" (ACC II )
40—55	10	Vendor PN	46 41 20 20 20 20 20 20	"SP4FSXCDFA" (ASC II )
56—59	4	Vendor rev	31 30 20 20	ASC II ( "31 30 20 20" means 1.0 revision)
60-61	2	Wavelength	03 52	850nm
62	1	Reserved	00	
63	1	CC BASE	xx	Check sum of bytes 0 - 62
64—65	2	Options	00 1A	LOS, TX_FAULT and TX_DISABLE
66	1	BR, max	00	
67	1	BR, min	00	
68—83	16	Vendor SN	xx xx xx xx xx xx xx xx	ASC II .



			xx xx xx xx xx xx xx xx	
84—91	8	Vendor date code	xx xx xx xx xx xx 20 20	Year (2 bytes, Month (2 bytes), Day (2 bytes)
92	1	Diagnostic type	68	Diagnostics(Int.Cal)
93	1	Enhanced ention	DΛ	Diagnostics (Optional Alarm/warning flags,
93	ı	Enhanced option	DU	Soft TX_FAULT and Soft TX_LOS monitoring)
94	1	SFF-8472	02	Diagnostics(SFF-8472 Rev 9.4)
95	1	CC EXT	xx	Check sum of bytes 64 - 94
96—255	160	Vendor specific		

Note: The "xx" byte should be filled in according to practical case. For more information, please refer to the related document of SFF-8472 Rev 9.5.

## **Monitoring Specification**

The digital diagnostic monitoring interface also defines another 256-byte memory map in EEPROM, which makes use of the 8 bit address 1010001X (A2h). Please see Figure 4. For detail EEPROM information, please refer to the related document of SFF-8472 Rev 9.5. The monitoring specification of this product is described in Table 8.

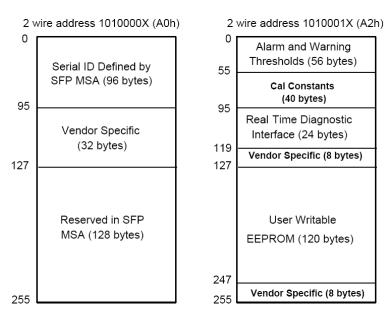


Figure 4, EEPROM Memory Map Specific Data Field Descriptions

**Table 8- Monitoring Specification** 

Parameter	Range	Accuracy	Calibration
Temperature	-10 to 80°C	±3°C	Internal
Voltage	3.0 to 3.6V	±3%	Internal
Bias Current	0 to 12mA	±10%	Internal
TX Power	-10 to -2.5dBm	±3dB	Internal



	4.25 Gb/s	-14 to 0dBm		
RX Power	2.125 Gb/s	-16 to 0dBm	±3dB	Internal
	1.0625 Gb/s	-17 to 0dBm		

# **Mechanical Diagram**

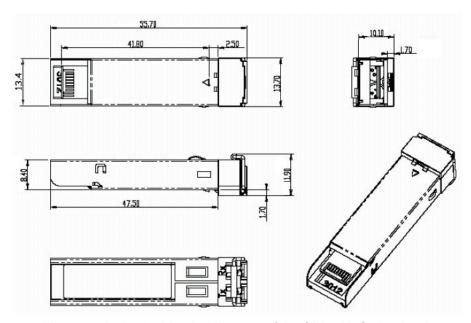


Figure 5, Mechanical Design Diagram of the SFP with Spring-Latch

### **Order Information**

**Table 9 - Order Information** 

Part No.	Application	Data Rate	Laser Source	Fiber Type
SP-4F-SX-CDFA	Fibre Channel	Tri-rate 1.0625/2.125/4.25Gbps	850nm VCSEL	MMF

# **Warnings**

**Handling Precautions:** This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures. **Laser Safety:** Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.



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